ABSOCIATION CONNECTING ELECTRONICS INDUSTRIES International and Pan-	C. Bannockl	burn. Illinois. A	ll rights reserved untions.	under both	This docum level parts, t	ent is a declara the declaration	ion of the s encompasse	ubstances es all lowe	within the r level mate	manufacture erials for wh	er listed item ich the man	n. Note: if ufacturer	f the item is an as has engineering	sembly with lower responsibility.
	IPC Web Site for Information on IPC-1752 Standard Form http://www.ipc.org/IPC-175x Distr				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia					als and Mfg Information				
Supplier Information														
Company name*	Company un	Company unique ID			Unique ID Authority					Response Date*				
nsemi											2025-06-03			
ntact Name Title - Contact			et				Phone - Contact*				Email - Contact*			
Product-Env-Stewards Product En			t Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Repr			Representative			Phone - Representative*				Email - Representative*				
Product-Env-Stewards Produ			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Iten	n Number	Mfr Item Name			Effective Dat	e Version	]	Manufacturing Site		We	ight*	UOM	Unit Type
	NCP303 G	CP303151AMNTW 50A IMON Po		wer Stage DRMOS		2025-06-03		]	MY5		86.	5633	mg	Each
Manufacturing Proccess Informat	ion													
Terminal Plating / Grid Array Mat	erial 7	Ferminal Base	Alloy J-STD-020 MSL R		L Rating	Peak Pro	Process Body Temperature M		re Max Tii	ne at Peak T	Temperature Number of Reflow Cycles		les	
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		1		260	260 C 3		30		seconds 3			
Comments														
level 1 - maximum time at peak temperatur	e during so	dering is 10-3	0 seconds											
For more information regarding material o	omposition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	6.8004	mg	Supplier	Zinc (Zn)	7440-66-6		0.0082	mg
			Supplier	Iron (Fe)	7439-89-6		0.1598	mg
			Supplier	Copper (Cu)	7440-50-8		6.6304	mg
			Supplier	Phosphorus (P)	7723-14-0		0.002	mg
Clip Attach	0.3	mg	Supplier	Silver (Ag)	7440-22-4		0.0075	mg
			А	Lead (Pb)	7439-92-1		0.2775	mg
			Supplier	Tin (Sn)	7440-31-5		0.015	mg
Die	2.7629	mg	Supplier	Silicon (Si)	7440-21-3		2.7629	mg
Ероху	4.401	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		0.3961	mg
			Supplier	Proprietary	Proprietary Data		0.0242	mg
			Supplier	Bismaleimide	13676-54-5		2.2203	mg
			Supplier	PTFE	9002-84-0		1.7604	mg
Lead Frame	32.9996	mg	Supplier	Zinc (Zn)	7440-66-6		0.0396	mg
			Supplier	Iron (Fe)	7439-89-6		0.7755	mg
			Supplier	Copper (Cu)	7440-50-8		32.1746	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0099	mg
Mold Compound-Black	36.0995	mg		Epoxy resin	proprietary data		4.8012	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0722	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		31.2261	mg
Plating	2.9998	mg	Supplier	Tin (Sn)	7440-31-5		2.9998	mg
Wire Bond - Cu	0.2001	mg	Supplier	Palladium (Pd)	7440-05-3		0.0036	mg
			Supplier	Gold (Au)	7440-57-5		0.0002	mg
			Supplier	Copper (Cu)	7440-50-8		0.1963	mg